

GALLIUM NITRIDE BASED SEMICONDUCTOR LIGHT EMITTING ELEMENT AND ITS MANUFACTURING METHOD

Patent number: JP2001217503

Publication date: 2001-08-10

Inventor: KIDOGUCHI ISAO; ISHIBASHI AKIHIKO; SUGAWARA TAKESHI; TSUJIMURA AYUMI; MIYANAGA RYOKO; KUME MASAHIRO; BAN YUZABURO

Applicant: MATSUSHITA ELECTRIC IND CO LTD

Classification:

- international: H01S5/22; H01L33/00

- european:

Application number: JP20000025929 20000203

Priority number(s):

Abstract of JP2001217503

PROBLEM TO BE SOLVED: To form a GaN based semiconductor laser of high reliability with superior yield.

SOLUTION: After an N-AlGaIn clad layer is deposited on a substrate, the clad layer is worked in a ridge type, and a ridge side surface and a recess bottom part are covered with SiNx. The C face of the clad layer is made seed crystal, and an N-optical guide layer, an active layer, a P-light guide layer, a P-clad layer and a P-GaN layer are grown, thereby forming the GaN based semiconductor laser. As a result, a single transverse mode laser of high reliability can be formed with superior yield.

